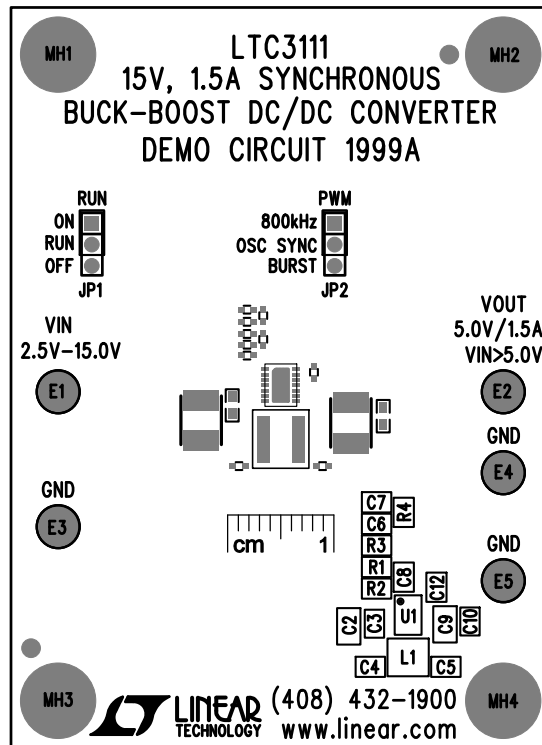


REVISION HISTORY

ECO	REV	DESCRIPTION	APPR	DATE
-	3	PRODUCTION FAB	JB	2-6-14

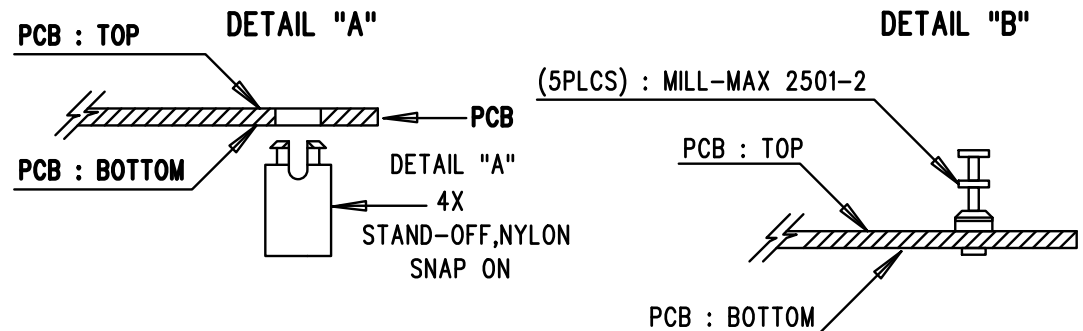
NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS
LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER.
MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELCIUS.
7. INSTALL TURRETS AND STAND-OFFS AS SHOWN BELOW:



DETAIL "A"

DETAIL "B"



APPROVALS

	INIT
PCB DES.	NC
APP ENG.	JB



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TITLE: TOP ASSEMBLY DRAWING:
15V, 1.5A SYNCHRONOUS
BUCK-BOOST DC/DC CONVERTER

SIZE	IC NO.	REV.
N/A	LTC3111EDHD DEMO CIRCUIT 1999A	3

SCALE = NONE

FILENAME: DC1999A-3.PCB

SHT 1 of 2